

Description and Testing of the GTR Surface Model

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Tim Younkin

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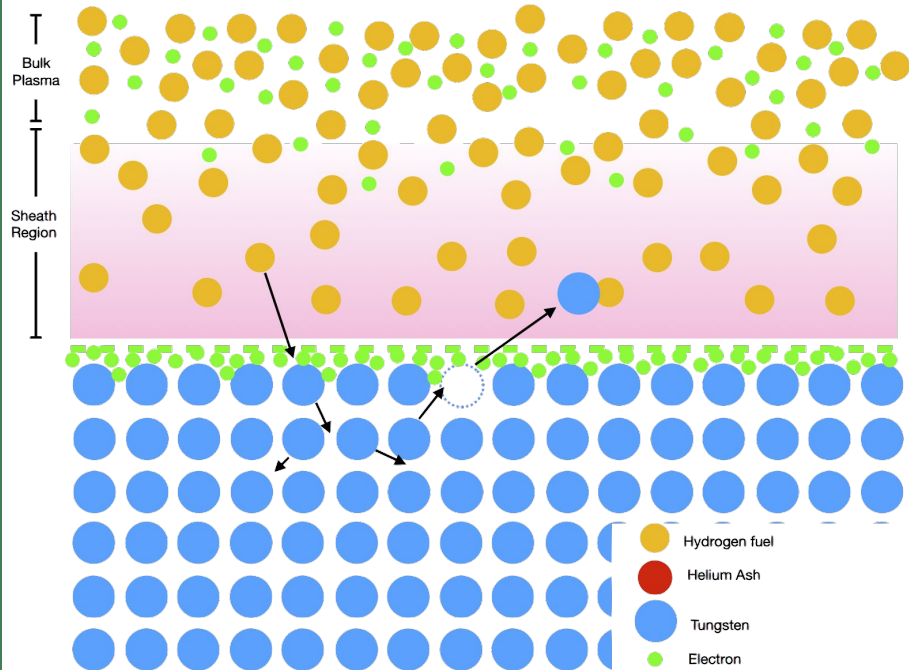


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What do we mean by surface model?

- We mean what happens when an atom/ion hits the surface
 - Deposition
 - Sputtering
 - Reflection

Physical sputtering of wall material is the predominant source of impurities during steady-state plasmas



$$Y(Ion, Material, E_{impact}, \theta_{impact})$$

Sputtered atom energy and angular distributions of sputtered particles are dependent on material properties such as surface binding energy E_b

- Charged particle physical sputtering (hydrogen and impurities)
- Chemical sputtering
- Neutral particle sputtering (fast charge exchange)
- Evaporation of material from over-heating
- Desorption from the wall surface by ions, electrons, or photons
- Arcing and run-away electrons

	Erosion Rate	Erosion per year	Lifetime (shots)
Gross Erosion	2 nm/s	6 cm	10,000
Net Erosion	0.3 nm/s	0.9 cm	60,000

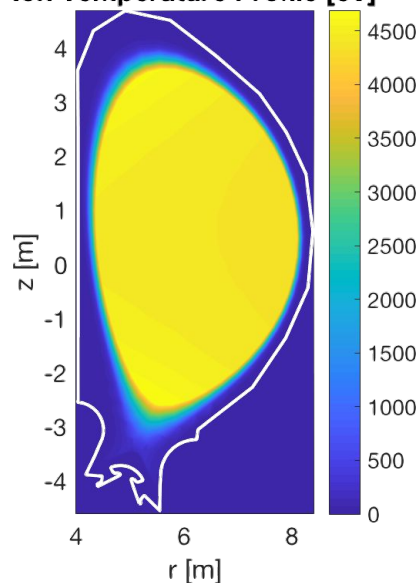
Estimates are based on steady-state assumptions for 400s Q=10 ITER discharge.

Varying Temporal and Spatial Scale Physics Create the Need for Integrated Physics Models

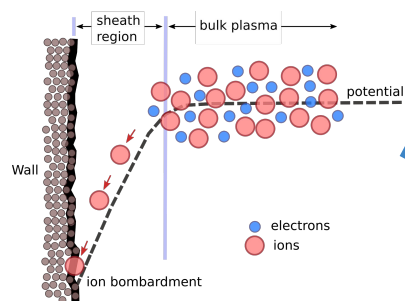
Bulk Plasma - Meter length scale, evolves on millisecond time scale.

Averaged particle motion can be treated as a fluid.

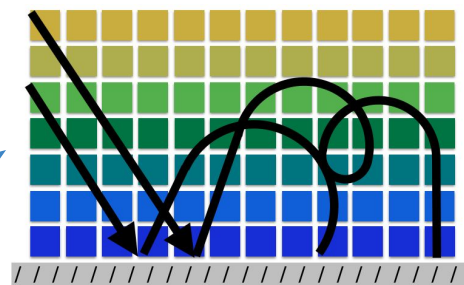
ITER He Operation
Ion Temperature Profile [eV]



Ion-surface interaction - Sputtering, reflection, and implantation occur on the nm length scale and ns time scale.

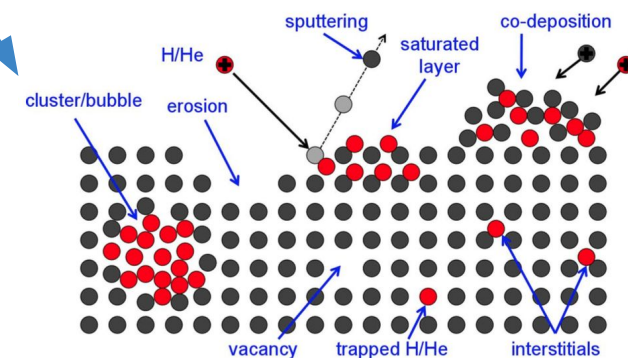


Sheath electric field structures - micron length scale, evolves on the sub-microsecond times.



Surface sputtering, impurity migration, and redeposition - nanosecond to second migration times, nanometers to many meters.

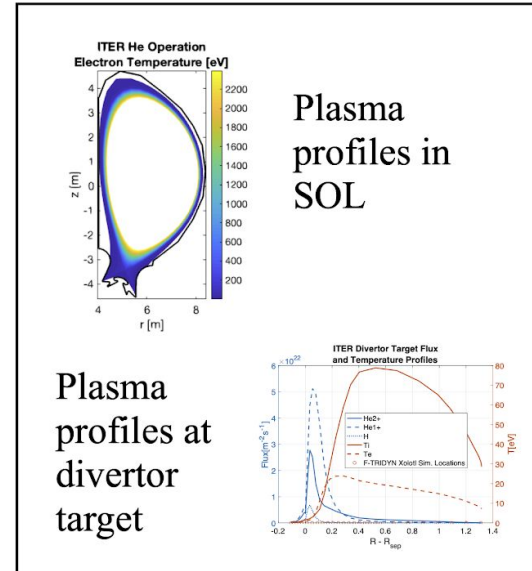
Erosion and implantation of ions. Subsurface concentration formations and surface morphology evolution - nm to meters. from seconds to years



PSI Workflow

SOLPS

HPIC



Target profiles
 T_e T_i $\bar{\Gamma}_i$ \bar{n}_i B α

SOL
 T_e
 T_i
 n_e
 n_i
 \bar{v}_i
 \bar{E}

Background
 $f_i(E, \theta)$

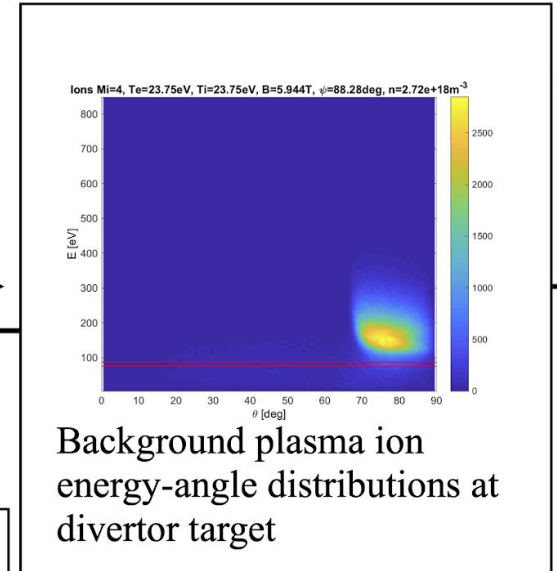
$$\bar{Y}_i = \frac{\iint f_i(E, \theta) Y_{iW}(E, \theta) dE d\theta}{\sum_i \iint f_i(E, \theta) dE d\theta}$$

$$\Gamma_{W\text{eroded}} = \sum_i \bar{Y}_i * \Gamma_{i\text{total}}$$

ITER Target Sputtering Yield and Eroded W Flux

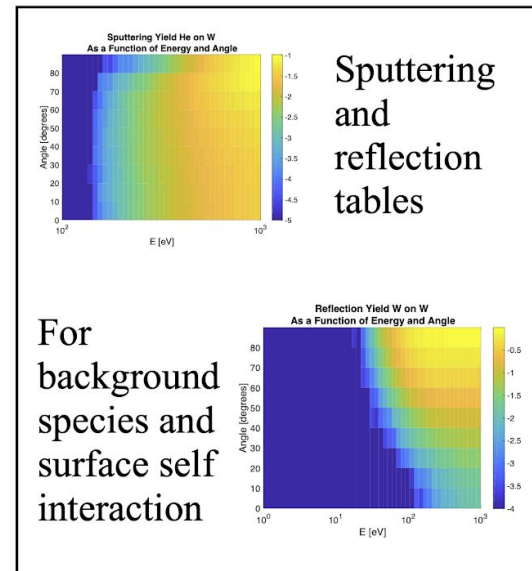
Background
 $Y_{iW}(E, \theta)$

W self-interaction
 $Y_{WW}(E, \theta)$ $R_{WW}(E, \theta)$

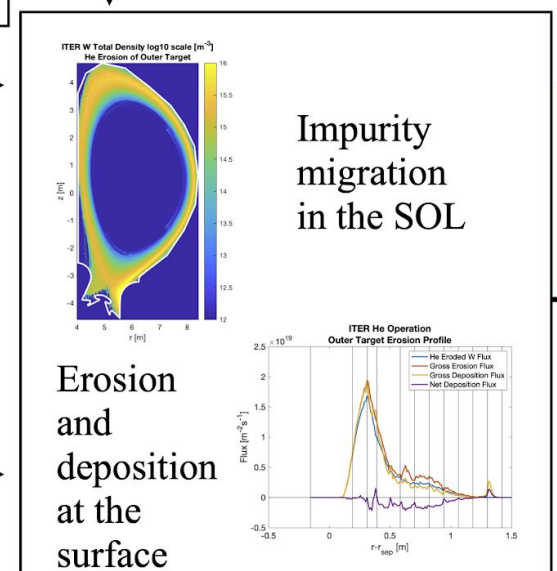


Background
 $f_i(E, \theta)$
 $\bar{\Gamma}_i$

F-TRIDYN



GITR



Impurity
 $\Gamma_{W\text{surface}}$
 $f_W(E, \theta)$

What is the current approach in GITR?

- Currently, GITR treats erosion due to the “background” plasma as a constant in time. This an input and gives a steady state flux “boundary condition” of eroded atoms.
- The material which is being eroded is the atom/impurity species which is tracked, which interacts with the surface of the same material.
- In mixed material systems we have treated impacts on materials different than the impurity species as 100% deposition (no sputtering or reflection).

Tracking eroded and reflected species uses a statistical/computational weighting approach

- GITR CPC paper example
- $Y = 0.1$, $R = 0.5$
- $nP = 100$ particles hit a surface, all which initially have weight 1
- 10 will sputter, 50 will reflect, 50 will gross deposit, 40 will net deposit
- We now represent the 10 sputtered particles as $Y \cdot nP / (Y + R) = 17$ computational particles with weight $(Y + R) = 0.6$
- The 50 reflected particles are represented as $R \cdot nP / (Y + R) = 83$ computational particles with weight $(Y + R) = 0.6$

The outcome

- This example ignores the details of transport, but as long as the particles continue to hit the walls, there will be deposition, sputtering, and reflection.
- The weight of the particles will continue to approach zero.

$$\begin{aligned} \text{grossDeposition} &= nP * (1 - R) \sum_{i=1}^{\infty} (Y + R)^i \\ &= nP * \frac{1 - R}{1 - (Y + R)} \quad (9) \end{aligned}$$

The outcome

```
K>> sum(grossDep(:))
```

```
ans =
```

```
1.249999839624124e+03
```

```
K>> sum(grossEro(:))
```

```
ans =
```

```
1.249999839624136e+03
```

```
K>> sum(grossDep(:))-sum(grossEro(:))
```

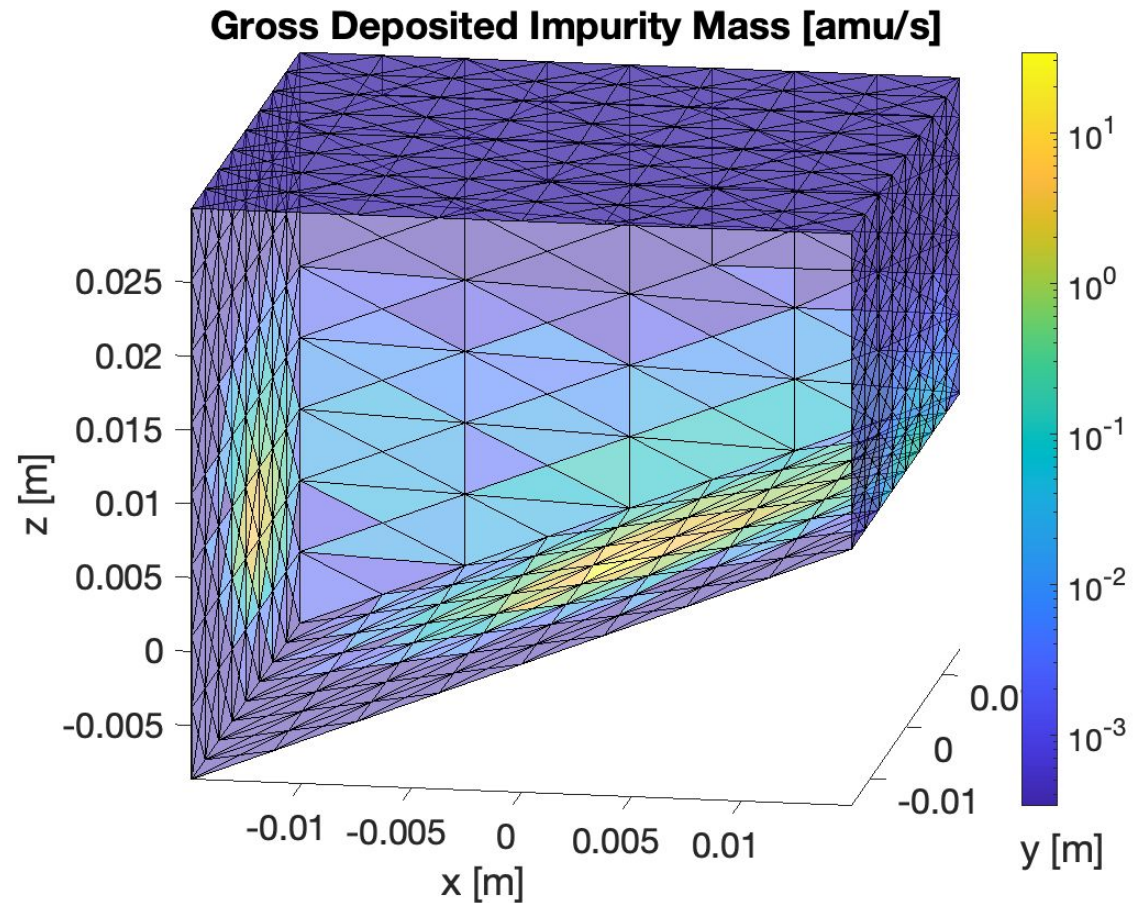
```
ans =
```

```
-1.227817847393453e-11
```

```
K>> sum(weight(:))
```

```
ans =
```

```
1.217912297328868e-11
```

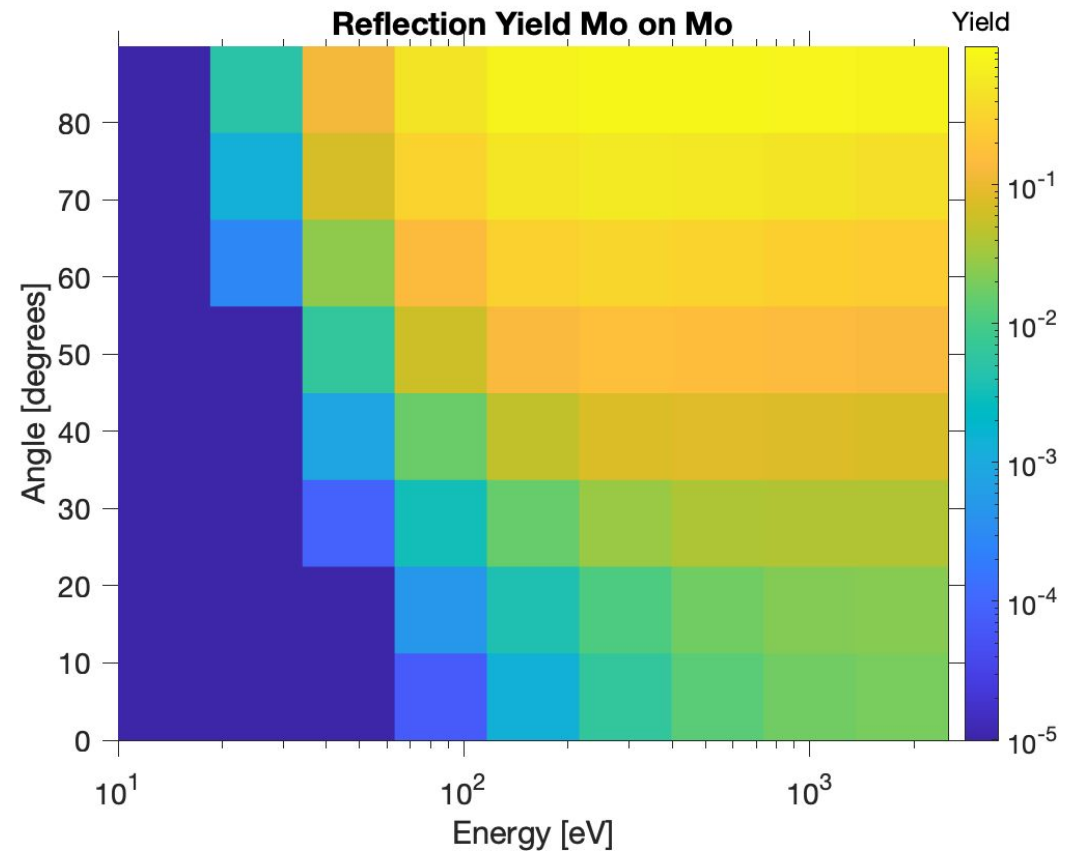
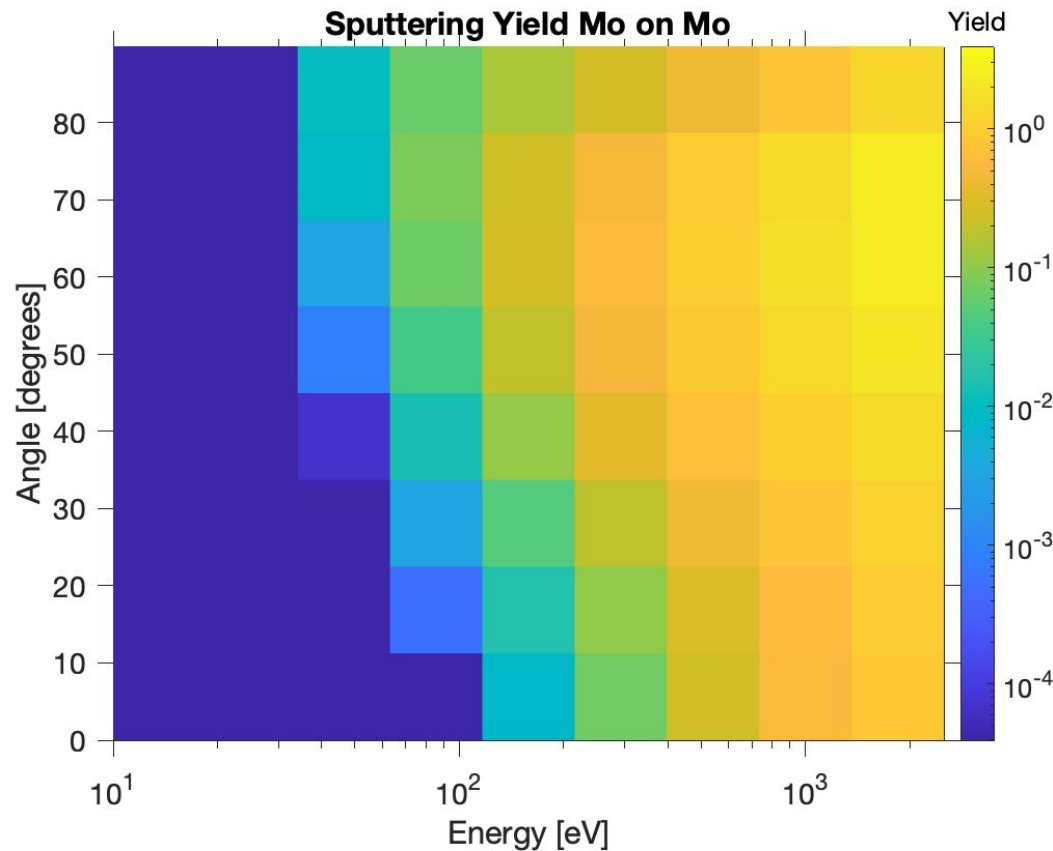


Good things about this approach

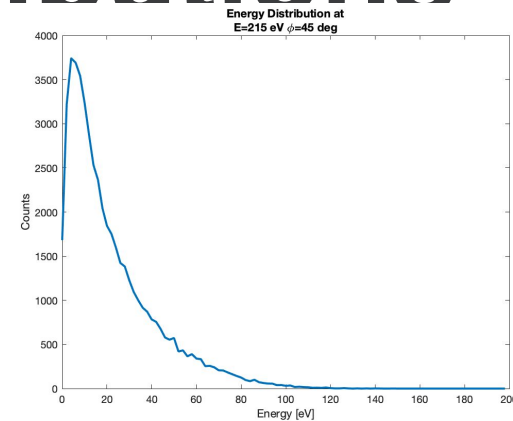
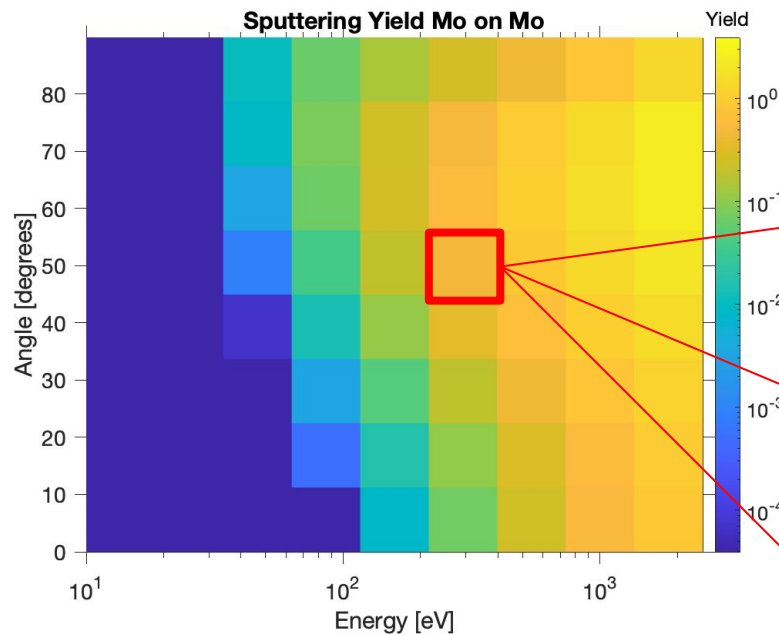
- The benefit of this approach is that we are using all of our simulated particles all the time (in this example where Y and R are always > 0).
- We know how many particles we have, so we can predict execution time (i.e., we're not spawning new particles which could add to unpredictability in runtime).
- We are getting better statistics than we would if we were killing off 40% of our particles each generation of impact (We're getting more lower weight impacts, as opposed to a single weight 1 impact for each sputtered/reflected particle).

How do we use F-TRIDYN

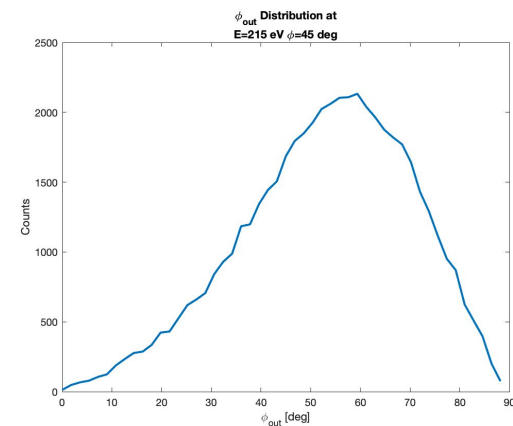
We run lots of FT simulations with fixed energy and angle of impact to create look-up tables for GITR.



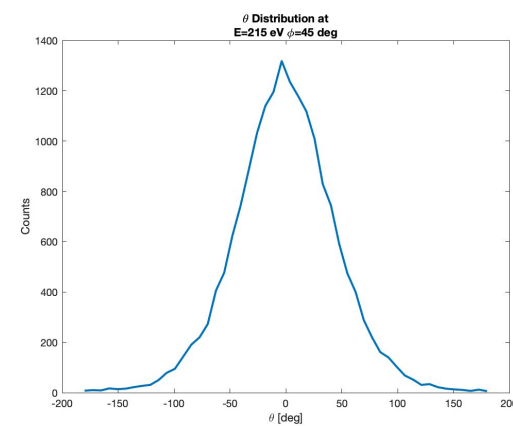
Each tile gives 3 distributions



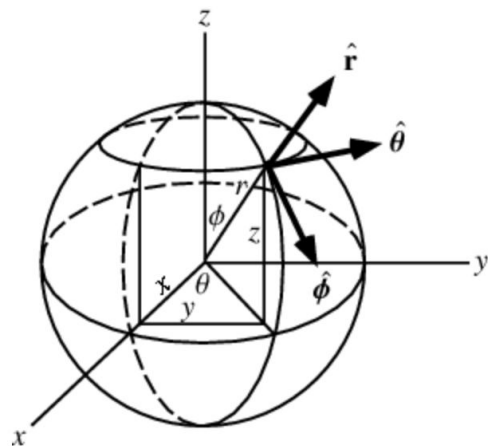
$f(E)$



$f(\phi)$

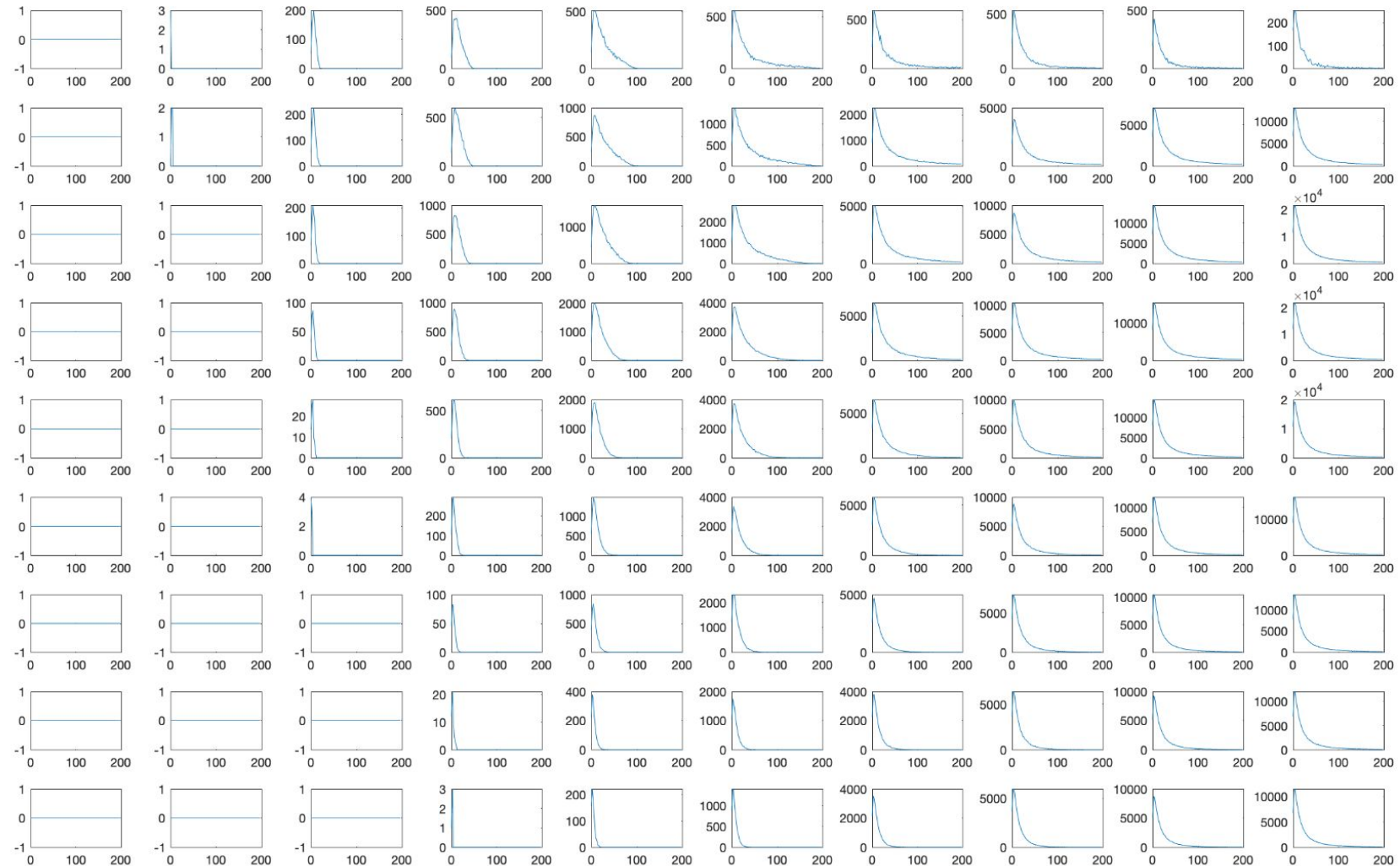
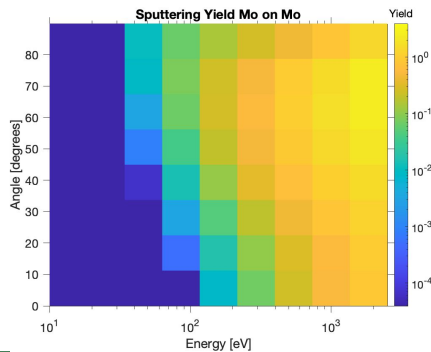


$f(\theta)$

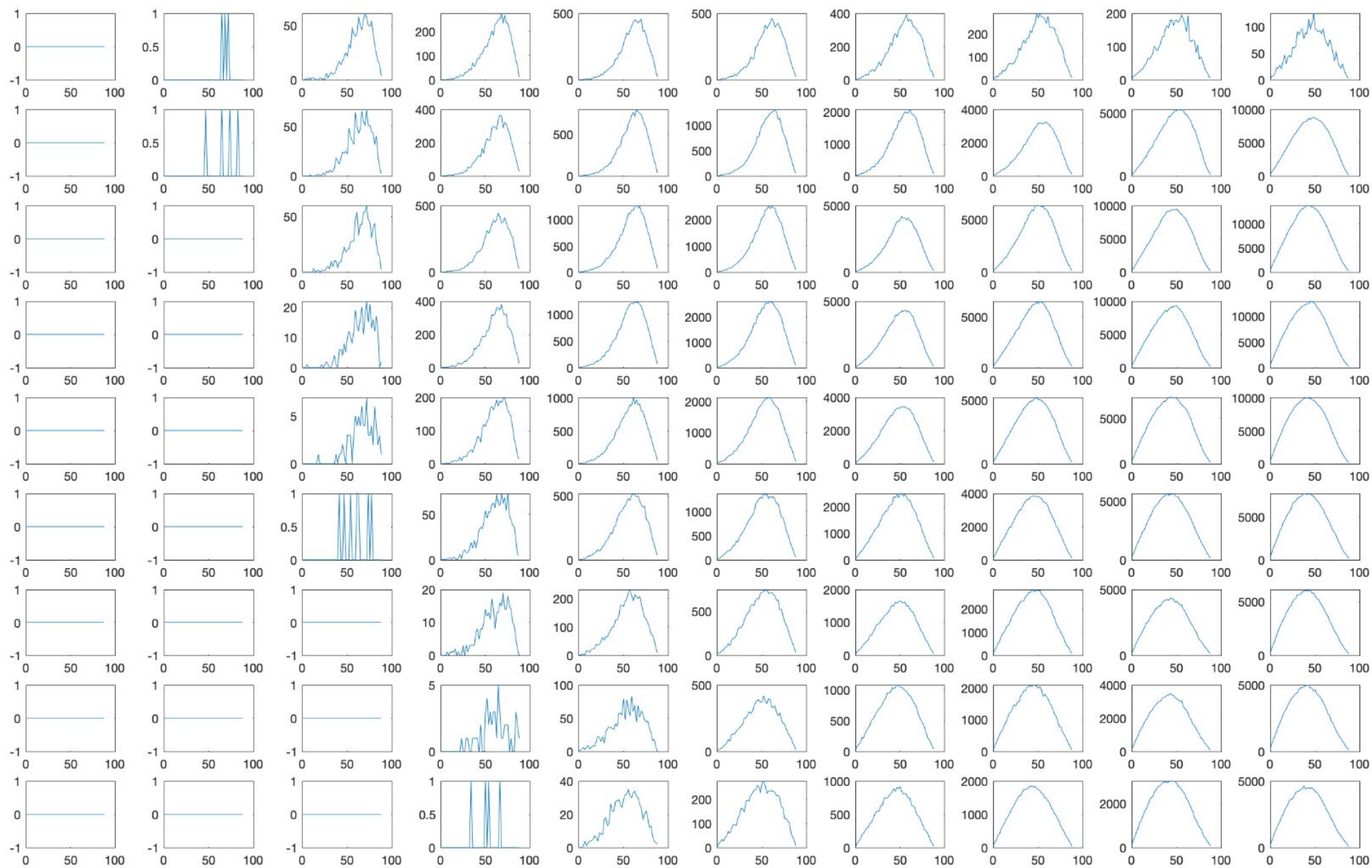


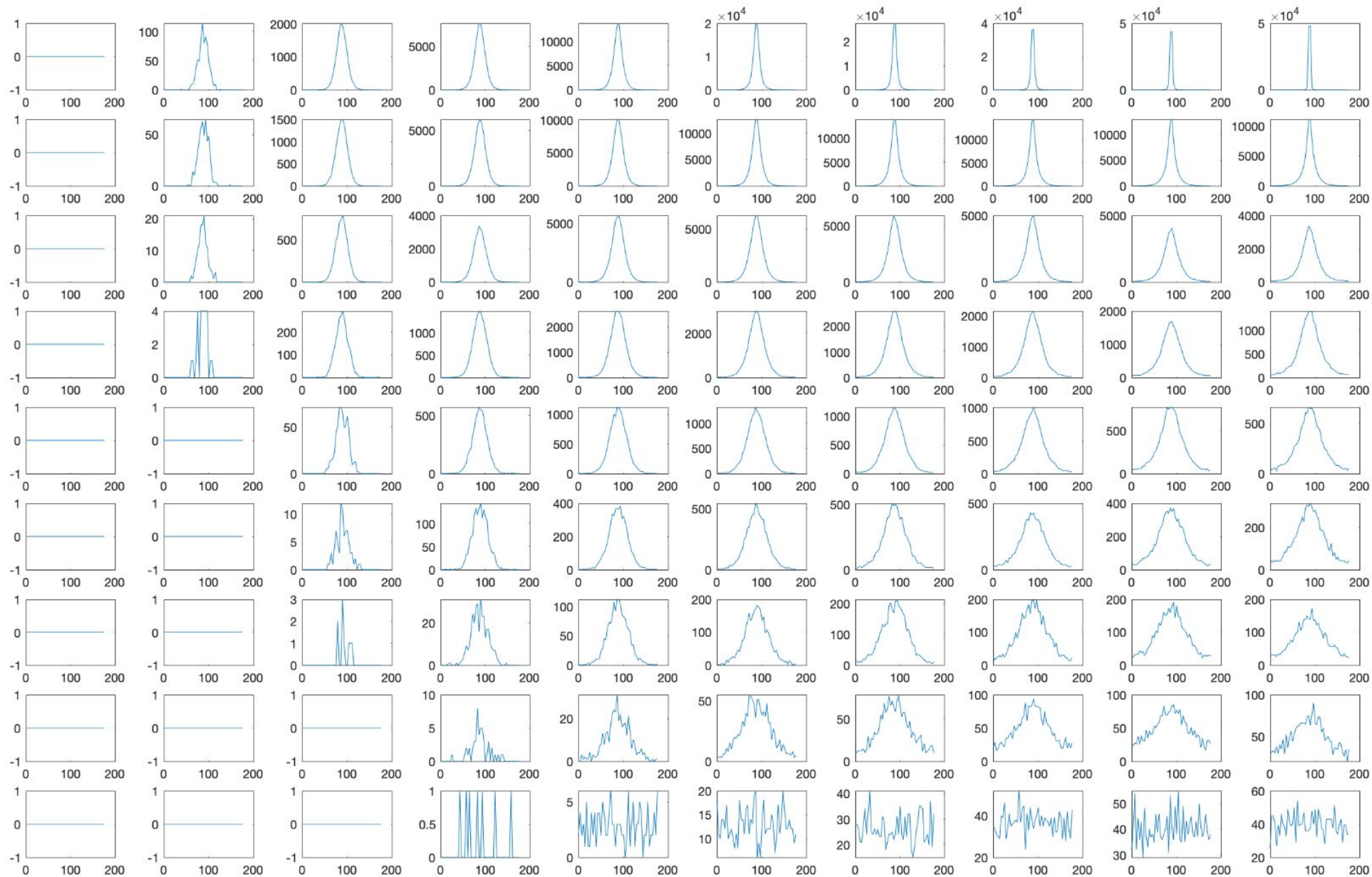
Sputtered Atom Energy Distribution

Impact
Angle

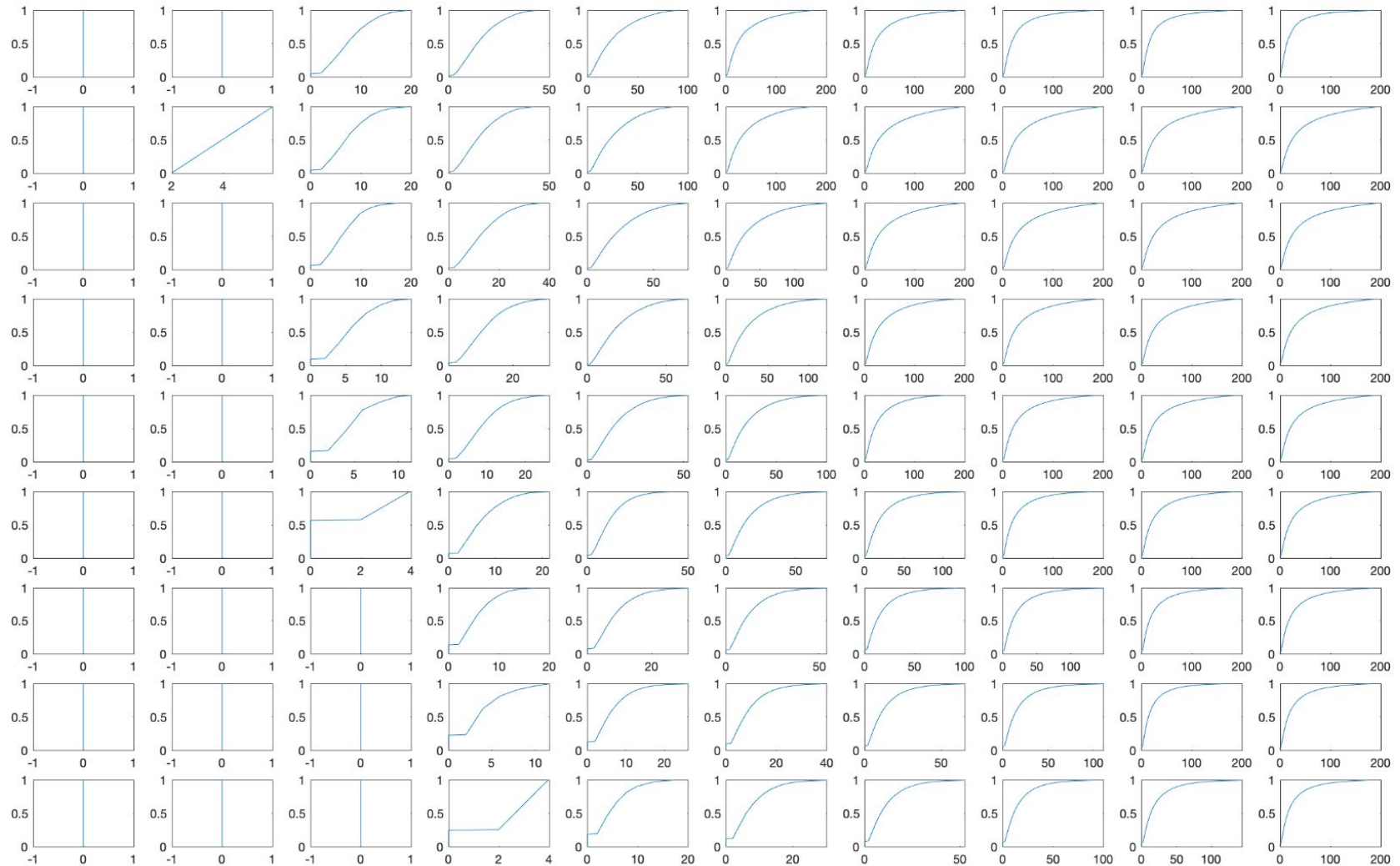


Impact
Energy





Further processing within GTR makes these into regularly spaced CDFs



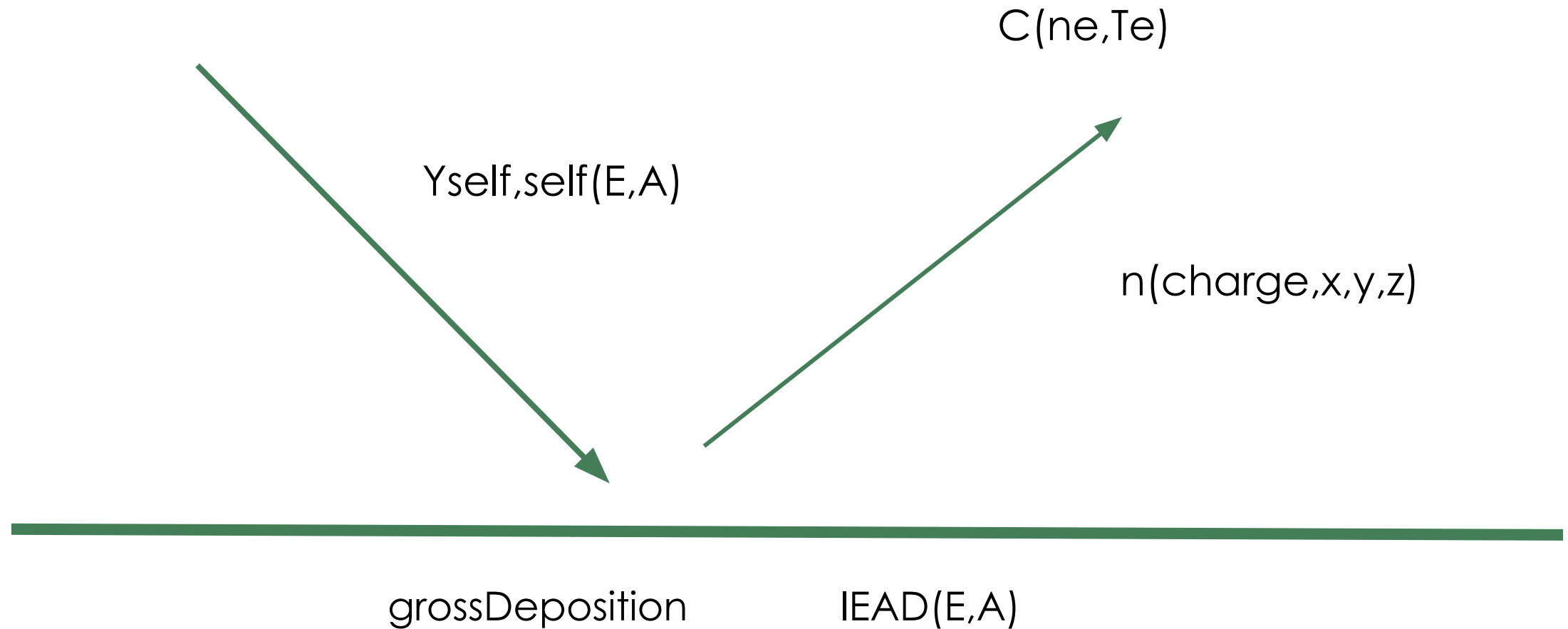
Drawbacks to current surface model

- No correlation between 1D distributions (energy, angles)
 - low energy sputtering may be high angle and vice versa, but GTR averages over them all.
- Low sputtering yield will inherently have bad distributions. Adding more particles will give lower yields which will also have poor distributions.
- Interpolation between energies/angle distributions doesn't really represent the physical processes

Going to Multi-species

- Currently, GTR simulations of different species can be run separately.
- This omits the effect of impurities reflecting off of and sputtering material of a different surface composition.

This requires added dimensions for storage arrays (inputs and outputs)



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